

## General Description

- Advanced Trench MOS Technology
- 100% EAS Guaranteed
- Low  $R_{DS(ON)}$
- Green Device Available

## Product Summary

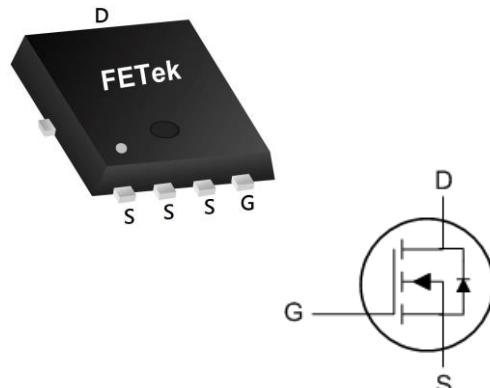


BVDSS	RDS(on)	ID
80V	3.0mΩ	100A

## Applications

- Power Tools.
- UPS
- Synchronous Rectification in SMPS.

## PRPAK5X6 Pin Configuration



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	80	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1.6}$	100	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1.6}$	99	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	250	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	784	mJ
$I_{AS}$	Avalanche Current	56	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation <sup>4</sup>	125	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	---	55	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	---	1	°C/W



FETek Technology Corp.

FKBA8074A

N-Ch 80V Fast Switching MOSFETs

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	80	---	---	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{\text{GS}}=10\text{V}$ , $I_D=20\text{A}$	---	2.3	3.0	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D=250\mu\text{A}$	2	2.8	4	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=64\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=64\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=55^\circ\text{C}$	---	---	5	
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	1.4	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=64\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_D=20\text{A}$	---	104	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	23.8	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	28.9	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=40\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=3\Omega$ , $I_D=20\text{A}$	---	22	---	ns
$T_r$	Rise Time		---	16	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	54	---	
$T_f$	Fall Time		---	16	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=40\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	6286	---	pF
$C_{\text{oss}}$	Output Capacitance		---	1108	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	50	---	

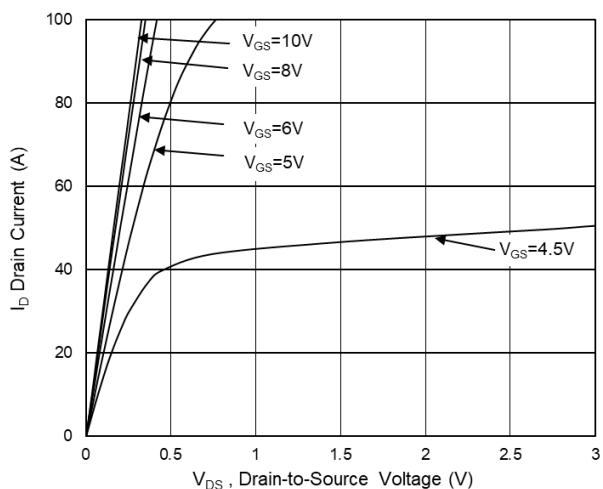
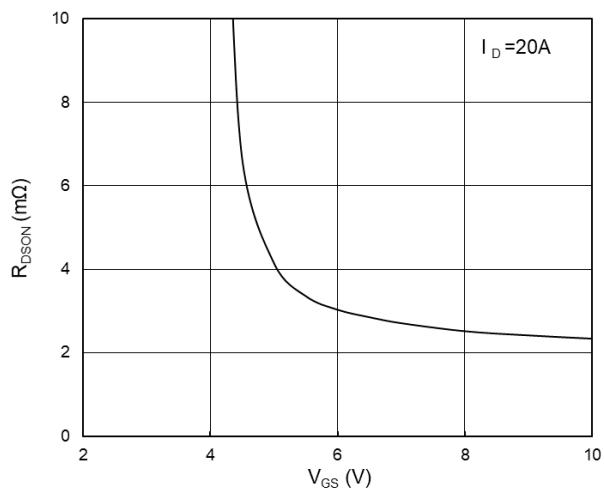
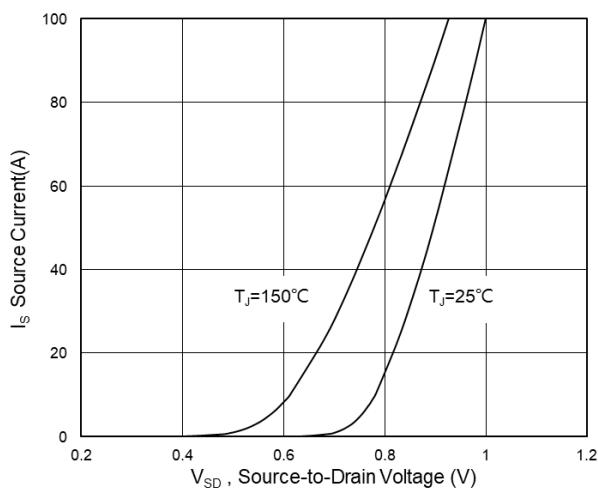
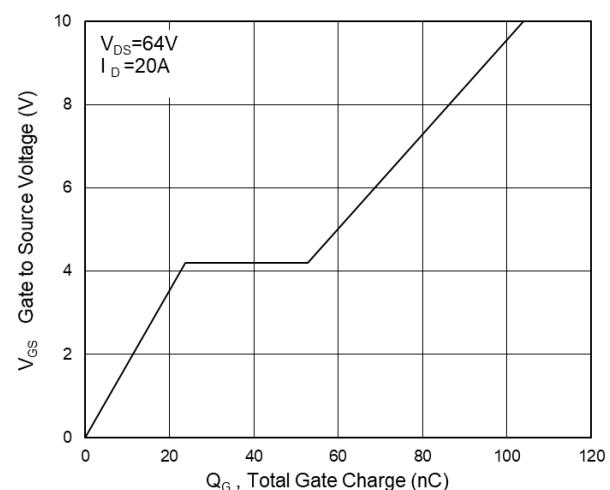
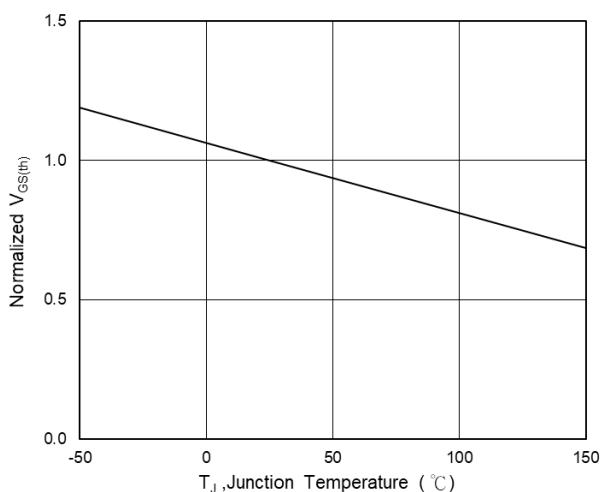
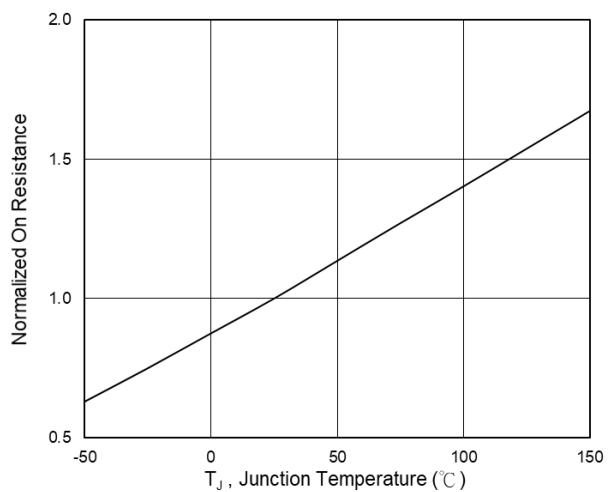
## Diode Characteristics

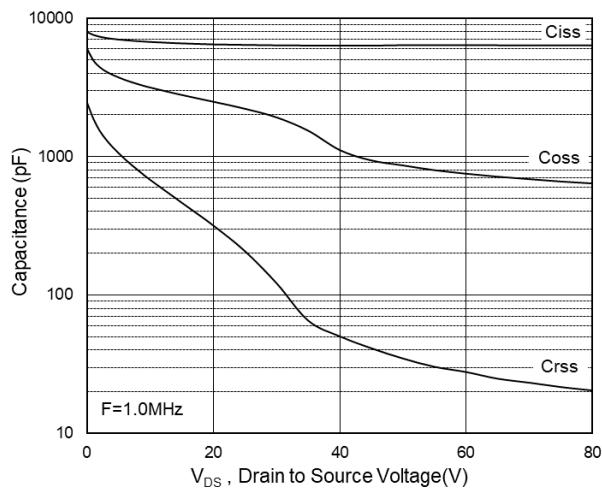
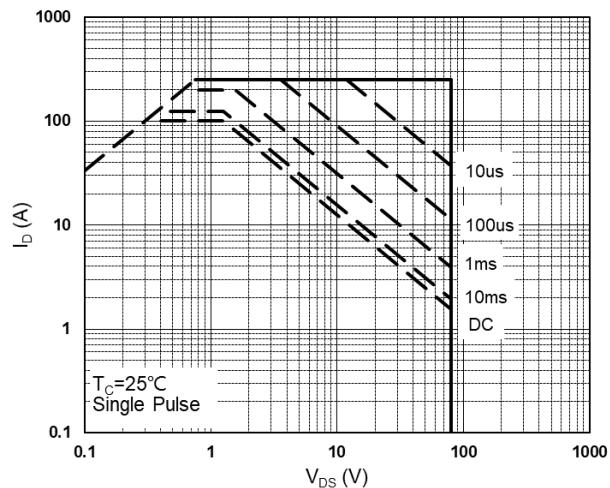
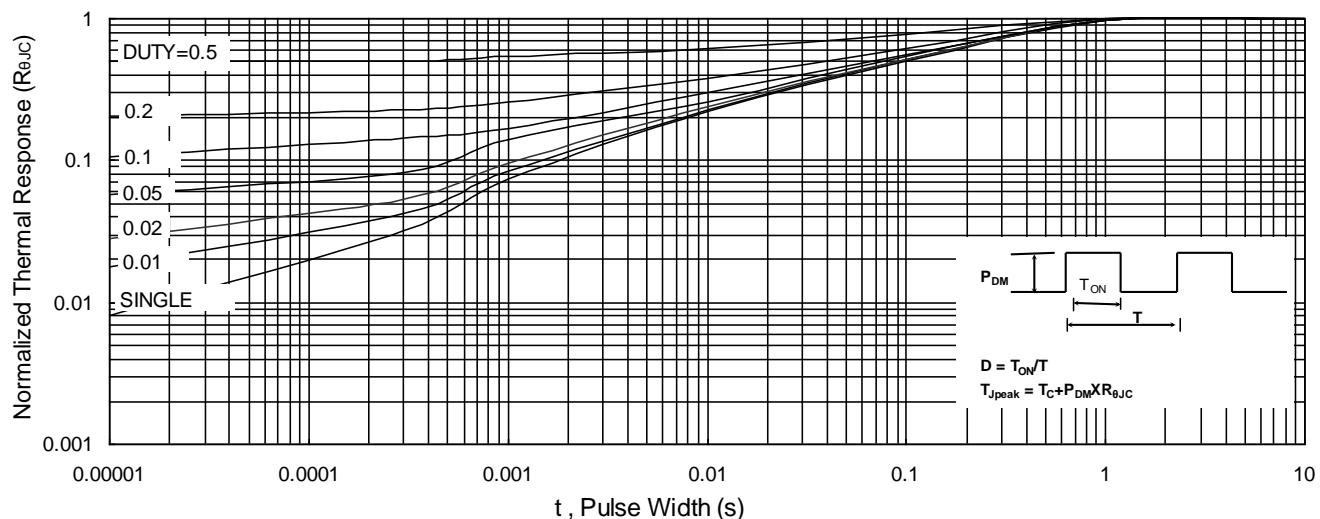
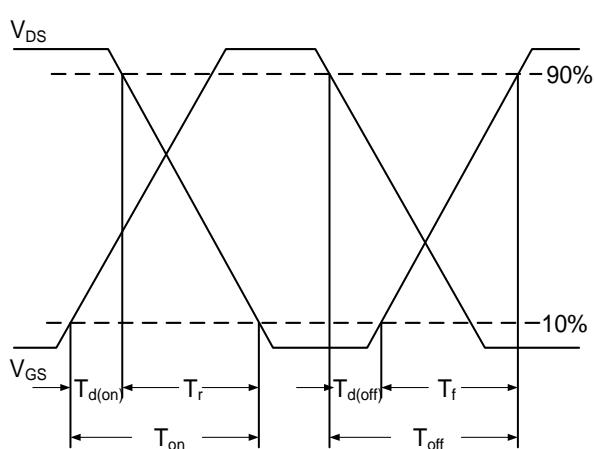
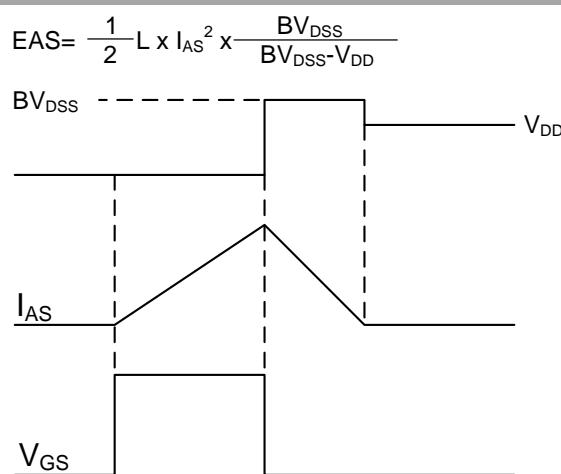
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current <sup>1,6</sup>	$V_G=V_D=0\text{V}$ , Force Current	---	---	100	A
$V_{\text{SD}}$	Diode Forward Voltage <sup>2</sup>	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	60	---	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		---	59	---	nC

## Note :

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $I_{\text{AS}}=56\text{A}$
- 4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
- 5.The data is theoretically the same as  $I_D$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.
- 6.Package limitation current is 100A.

### Typical Characteristics


**Fig.1 Typical Output Characteristics**

**Fig.2 On-Resistance vs G-S Voltage**

**Fig.3 Source Drain Forward Characteristics**

**Fig.4 Gate-Charge Characteristics**

**Fig.5 Normalized  $V_{GS(th)}$  vs  $T_J$** 

**Fig.6 Normalized  $R_{DS(on)}$  vs  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Switching Waveform**